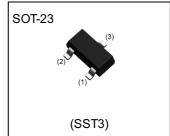


PNP -100mA -50V Digital Transistors (Bias Resistor Built-in Transistors)

| Parameter            | Value  |  |  |
|----------------------|--------|--|--|
| V <sub>CC</sub>      | -50V   |  |  |
| I <sub>C(MAX.)</sub> | -100mA |  |  |
| R <sub>1</sub>       | 4.7kΩ  |  |  |
| R <sub>2</sub>       | 4.7kΩ  |  |  |

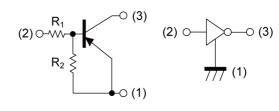
## ●Outline



#### Features

- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 4.7k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC143ECA

#### •Inner circuit



- (1) GND (+) (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

## Application

INVERTER, INTERFACE, DRIVER

### Packaging specifications

| Part No.  | Package          | Package<br>size | Taping<br>code | Reel size<br>(mm) | Tape width<br>(mm) | Basic<br>ordering<br>unit.(pcs) | Marking |
|-----------|------------------|-----------------|----------------|-------------------|--------------------|---------------------------------|---------|
| DTA143ECA | SOT-23<br>(SST3) | 2924            | T116           | 180               | 8                  | 3000                            | 13      |

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

| Parameter                    | Symbol                 | Values      | Unit |
|------------------------------|------------------------|-------------|------|
| Supply voltage               | V <sub>CC</sub>        | -50         | V    |
| Input voltage                | V <sub>IN</sub>        | -30 to 10   | V    |
| Output current               | Io                     | -100        | mA   |
| Collector current            | I <sub>C(MAX)</sub> *1 | -100        | mA   |
| Decree die de alie e         | P <sub>D</sub> *2      | 200         | mW   |
| Power dissipation            |                        | 350         | mW   |
| Junction temperature         | T <sub>j</sub>         | 150         | °C   |
| Range of storage temperature | T <sub>stg</sub>       | -55 to +150 | °C   |

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

| Dougnoston           | C: resh al                     | Conditions  | Values |      |      | 1.1  |  |
|----------------------|--------------------------------|---|--------|------|------|------|--|
| Parameter            | Symbol                         | Conditions  | Min.   | Тур. | Max. | Unit |  |
| land the state of    | $V_{I(off)}$                   | $V_{CC} = -5V, I_{O} = -100\mu A$                           | -      | -    | -0.5 | - v  |  |
| Input voltage        | V <sub>I(on)</sub>             | $V_O = -0.3V$ , $I_O = -20$ mA                              | -3.0   | -    | -    |      |  |
| Output voltage       | V <sub>O(on)</sub>             | $I_{O}/I_{I} = -10 \text{mA} / -0.5 \text{mA}$              | -      | -100 | -300 | mV   |  |
| Input current        | I <sub>I</sub>                 | V <sub>I</sub> = -5V  | -      | -    | -1.8 | mA   |  |
| Output current       | I <sub>O(off)</sub>            | $V_{CC} = -50V, V_{I} = 0V$                                 | -      | -    | -500 | nA   |  |
| DC current gain      | G <sub>I</sub>                 | $V_{O} = -5V, I_{O} = -10mA$                                | 30     | -    | -    | -    |  |
| Input resistance     | R <sub>1</sub>                 | -   | 3.29   | 4.7  | 6.11 | kΩ   |  |
| Resistance ratio     | R <sub>2</sub> /R <sub>1</sub> | -   | 0.8    | 1.0  | 1.2  | -    |  |
| Transition frequency | f <sub>T</sub> *1              | V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA,<br>f = 100MHz | -      | 250  | -    | MHz  |  |

<sup>\*1</sup> Characteristics of built-in transistor.

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3</sup> Mounted on a ceramic board(7.0×5.0×0.6mm).

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

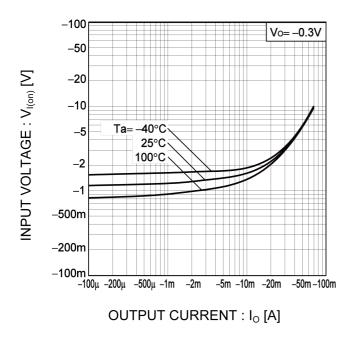


Fig.2 Output current vs. input voltage (OFF characteristics)

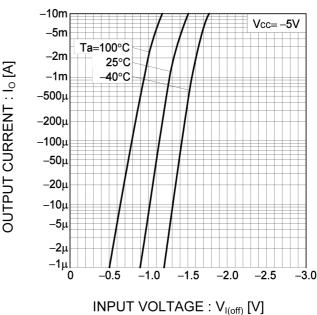


Fig.3 Output current vs. output voltage

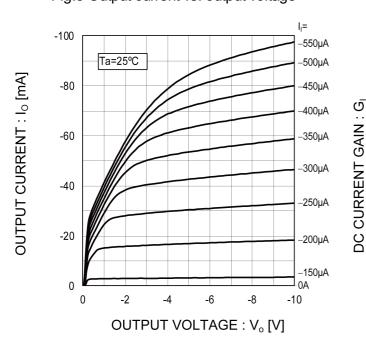
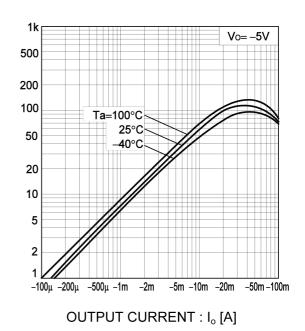
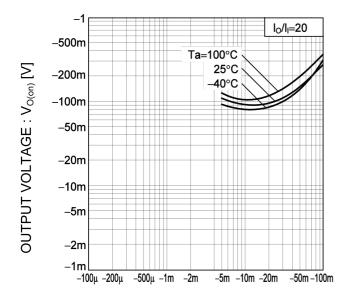


Fig.4 DC current gain vs. output current



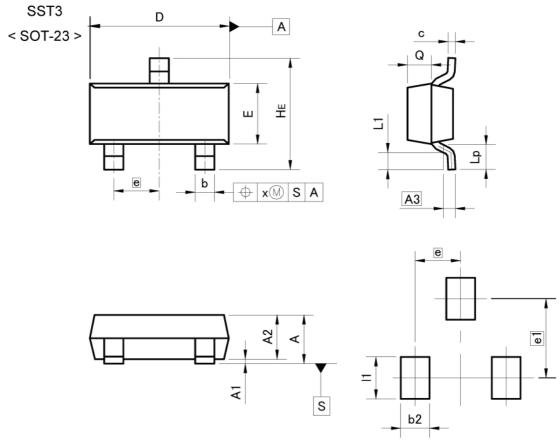
## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : Io [A]

### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIMETERS |       | INCHES |       |  |
|-----|------------|-------|--------|-------|--|
| DIM | MIN        | MAX   | MIN    | MAX   |  |
| Α   | 0.90       | 1.20  | 0.035  | 0.047 |  |
| A1  | 0.00       | 0.10  | 0.000  | 0.004 |  |
| A2  | 0.85       | 1.15  | 0.033  | 0.045 |  |
| A3  | 0.3        | 25    | 0.010  |       |  |
| b   | 0.35       | 0.50  | 0.014  | 0.020 |  |
| С   | 0.09       | 0.25  | 0.004  | 0.010 |  |
| D   | 2.70       | 3.10  | 0.106  | 0.122 |  |
| E   | 1.20       | 1.50  | 0.047  | 0.059 |  |
| е   | 0.9        | 95    | 0.0    | 37    |  |
| HE  | 2.20       | 2.60  | 0.087  | 0.102 |  |
| L1  | 0.20       | 00    | 0.008  | _     |  |
| Lp  | 0.30       | p.=.; | 0.012  | u=-   |  |
| Q   | 0.40       | 0.60  | 0.016  | 0.024 |  |
| х   | -,,        | 0.10  | -      | 0.004 |  |

| DIM  |    | MILIMETERS |      | INCHES |       |  |
|------|----|------------|------|--------|-------|--|
| DIN  | /1 | MIN        | MAX  | MIN    | MAX   |  |
| b2   |    | -          | 0.60 | _      | 0.024 |  |
| e1   |    | 1.70       |      | 0.0    | 67    |  |
| - 11 |    | -3         | 0.90 | -      | 0.035 |  |

Dimension in mm/inches



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|---------|-----------|------------|-----------|
| CLASSⅢ  | CL ACCIII | CLASS II b | CL ACCIII |
| CLASSIV | CLASSⅢ    | CLASSⅢ     | CLASSⅢ    |

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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For details, please refer to ROHM Mounting specification

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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